

ADVANCE PROGRAM

2 0 1 1
INTERNATIONAL CONFERENCE ON

SOLID STATE
DEVICES AND MATERIALS

Conference ___ September 28-30, 2011

Place _____ Aichi Industry & Labor Center
(WINC AICHI)

Short Course &
Workshop _____ September 27, 2011

Sponsored by
The Japan Society of Applied Physics
Technical-Cosponsored by
IEEE Electron Devices Society
in cooperation with

The Electrochemical Society of Japan

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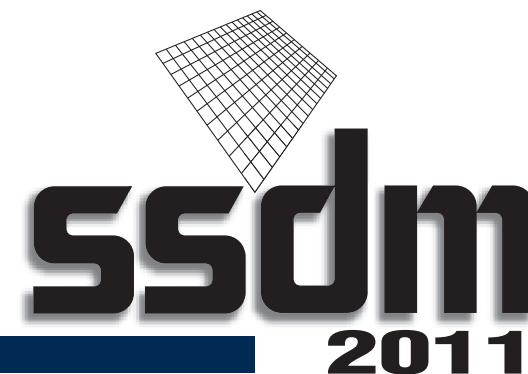
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The logo for the 2011 Solid State Devices and Materials (SSDM) conference. It features a stylized grid pattern above the lowercase letters 'ssdm' in a bold, sans-serif font. Below 'ssdm' is the year '2011' in a similar bold, sans-serif font.

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2011 International Conference on Solid State Devices and Materials (SSDM 2011)

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